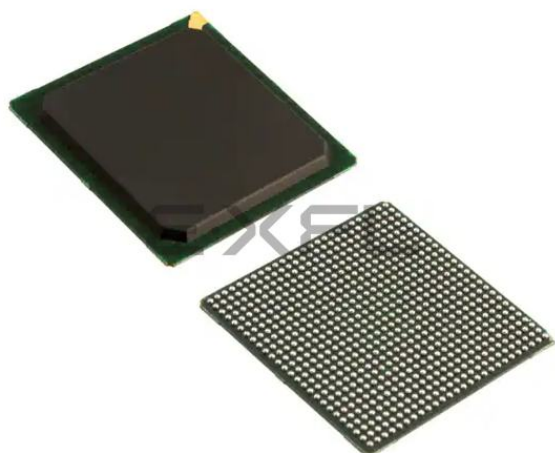




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Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Active
Number of LABs/CLBs	8064
Number of Logic Elements/Cells	-
Total RAM Bits	73728
Number of I/O	336
Number of Gates	500000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-55°C ~ 125°C (TA)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/ax500-1fgg676m

Timing Characteristics

Table 2-22 • 3.3 V LVTTL I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_j = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTL Output Drive Strength = 1 (8 mA) / Low Slew Rate								
t _{DP}	Input Buffer		1.68		1.92		2.26	ns
t _{PY}	Output Buffer		14.28		16.27		19.13	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		15.25		17.37		20.42	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		14.26		16.24		19.09	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.56		1.57		1.58	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		1.95		1.96		1.97	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Table 2-22 • 3.3 V LVTTTL I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C (continued)

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVTTTL Output Drive Strength = 2 (12 mA) / High Slew Rate								
t _{DP}	Input Buffer		1.68		1.92		2.26	ns
t _{PY}	Output Buffer		3.30		3.76		4.42	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		3.74		4.26		5.00	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		3.06		3.49		4.10	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		1.89		1.91		1.91	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		2.29		2.30		2.31	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Timing Characteristics

Table 2-28 • 1.8V LVCMOS I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 1.7 V, TJ = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
LVCMOS18 Output Module Timing								
t _{DP}	Input Buffer		3.26		3.71		4.37	ns
t _{PY}	Output Buffer		4.55		5.18		6.09	ns
t _{ENZL}	Enable to Pad Delay through the Output Buffer—Z to Low		2.82		2.83		2.84	ns
t _{ENZH}	Enable to Pad Delay through the Output Buffer—Z to High		3.43		3.45		3.46	ns
t _{ENLZ}	Enable to Pad Delay through the Output Buffer—Low to Z		6.01		6.85		8.05	ns
t _{ENHZ}	Enable to Pad Delay through the Output Buffer—High to Z		6.73		7.67		9.01	ns
t _{IOCLKQ}	Sequential Clock-to-Q for the I/O Input Register		0.67		0.77		0.90	ns
t _{IOCLKY}	Clock-to-output Y for the I/O Output Register and the I/O Enable Register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Voltage-Referenced I/O Standards

GTL+

Gunning Transceiver Logic Plus is a high-speed bus standard (JESD8-3). It requires a differential amplifier input buffer and an Open Drain output buffer. The VCCI pin should be connected to 2.5 V or 3.3 V. Note that 2.5 V GTL+ is not supported across the full military temperature range.

Table 2-37 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
N/A	VREF – 0.1	VREF + 0.1	N/A	0.6	NA	NA	NA

AC Loadings

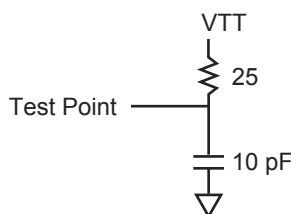


Figure 2-19 • AC Test Loads

Table 2-38 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
VREF – 0.2	VREF + 0.2	VREF	1.0	10

Note: * Measuring Point = VTRIP

Timing Characteristics

Table 2-39 • 2.5 V GTL+ I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 2.3 V, T_j = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
2.5 V GTL+ I/O Module Timing								
t _{DP}	Input Buffer		1.71		1.95		2.29	ns
t _{PY}	Output Buffer		1.13		1.29		1.52	ns
t _{ICKLKQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t _{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

SSTL3

Stub Series Terminated Logic for 3.3 V is a general-purpose 3.3 V memory bus standard (JESD8-8). The Axcelerator devices support both classes of this standard. This requires a differential amplifier input buffer and a push-pull output buffer.

Class I

Table 2-50 • DC Input and Output Levels

VIL		VIH		VOL	VOH	IOL	IOH
Min., V	Max., V	Min., V	Max., V	Max., V	Min., V	mA	mA
-0.3	VREF – 0.2	VREF + 0.2	3.6	VREF – 0.6	VREF + 0.6	8	–8

AC Loadings

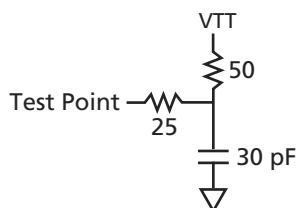


Figure 2-23 • AC Test Loads

Table 2-51 • AC Waveforms, Measuring Points, and Capacitive Loads

Input Low (V)	Input High (V)	Measuring Point* (V)	VREF (typ) (V)	C _{load} (pF)
VREF – 1.0	VREF + 1.0	VREF	1.50	30

Note: *Measuring Point = VTRIP

Timing Characteristics

Table 2-52 • 3.3 V SSTL3 Class I I/O Module

Worst-Case Commercial Conditions VCCA = 1.425 V, VCCI = 3.0 V, T_J = 70°C

		–2 Speed		–1 Speed		Std Speed		
Parameter	Description	Min.	Max.	Min.	Max.	Min.	Max.	Units
3.3 V SSTL3 Class I I/O Module Timing								
t _{DP}	Input Buffer		1.78		2.03		2.39	ns
t _{PY}	Output Buffer		2.17		2.47		2.91	ns
t _{ICKLQ}	Clock-to-Q for the I/O input register		0.67		0.77		0.90	ns
t _{OCLKQ}	Clock-to-Q for the I/O output register and the I/O enable register		0.67		0.77		0.90	ns
t _{SUD}	Data Input Set-Up		0.23		0.27		0.31	ns
t _{SUE}	Enable Input Set-Up		0.26		0.30		0.35	ns
t _{HD}	Data Input Hold		0.00		0.00		0.00	ns
t _{HE}	Enable Input Hold		0.00		0.00		0.00	ns
t _{CPWHL}	Clock Pulse Width High to Low	0.39		0.39		0.39		ns
t _{CPWLH}	Clock Pulse Width Low to High	0.39		0.39		0.39		ns
t _{WASYN}	Asynchronous Pulse Width	0.37		0.37		0.37		ns
t _{REASYN}	Asynchronous Recovery Time		0.13		0.15		0.17	ns
t _{HASYN}	Asynchronous Removal Time		0.00		0.00		0.00	ns
t _{CLR}	Asynchronous Clear-to-Q		0.23		0.27		0.31	ns
t _{PRESET}	Asynchronous Preset-to-Q		0.23		0.27		0.31	ns

Table 2-69 • AX2000 Predicted Routing Delays
Worst-Case Commercial Conditions VCCA = 1.425 V, T_J = 70°C

		-2 Speed	-1 Speed	Std Speed	
Parameter	Description	Typical	Typical	Typical	Units
Predicted Routing Delays					
t _{DC}	DirectConnect Routing Delay, FO1	0.12	0.13	0.15	ns
t _{FC}	FastConnect Routing Delay, FO1	0.35	0.39	0.46	ns
t _{RD1}	Routing delay for FO1	0.50	0.56	0.66	ns
t _{RD2}	Routing delay for FO2	0.59	0.67	0.79	ns
t _{RD3}	Routing delay for FO3	0.70	0.80	0.94	ns
t _{RD4}	Routing delay for FO4	0.76	0.87	1.02	ns
t _{RD5}	Routing delay for FO5	0.98	1.11	1.31	ns
t _{RD6}	Routing delay for FO6	1.48	1.68	1.97	ns
t _{RD7}	Routing delay for FO7	1.65	1.87	2.20	ns
t _{RD8}	Routing delay for FO8	1.73	1.96	2.31	ns
t _{RD16}	Routing delay for FO16	2.58	2.92	3.44	ns
t _{RD32}	Routing delay for FO32	4.24	4.81	5.65	ns

Axcelerator Clock Management System

Introduction

Each member of the Axcelerator family⁶ contains eight phase-locked loop (PLL) blocks which perform the following functions:

- Programmable Delay (32 steps of 250 ps)
- Clock Skew Minimization
- Clock Frequency Synthesis

Each PLL has the following key features:

- Input Frequency Range – 14 to 200 MHz
- Output Frequency Range – 20 MHz to 1 GHz
- Output Duty Cycle Range – 45% to 55%
- Maximum Long-Term Jitter – 1% or 100ps (whichever is greater)
- Maximum Short-Term Jitter – 50ps + 1% of Output Frequency
- Maximum Acquisition Time (lock) – 20μs

Physical Implementation

The eight PLL blocks are arranged in two groups of four. One group is located in the center of the northern edge of the chip, while the second group is centered on the southern edge. The northern group is associated with the four HCLK networks (e.g. PLLA can drive HCLKA), while the southern group is associated with the four CLK networks (e.g. PLLE can drive CLKE).

Each PLL cell is connected to two I/O pads and a PLL Cluster that interfaces with the FPGA core. Figure 2-48 illustrates a PLL block. The VCCPLL pin should be connected to a 1.5V power supply through a 250 Ω resistor. Furthermore, 0.1 μF and 10 μF decoupling capacitors should be connected across the VCCPLL and VCOMPPLL pins.

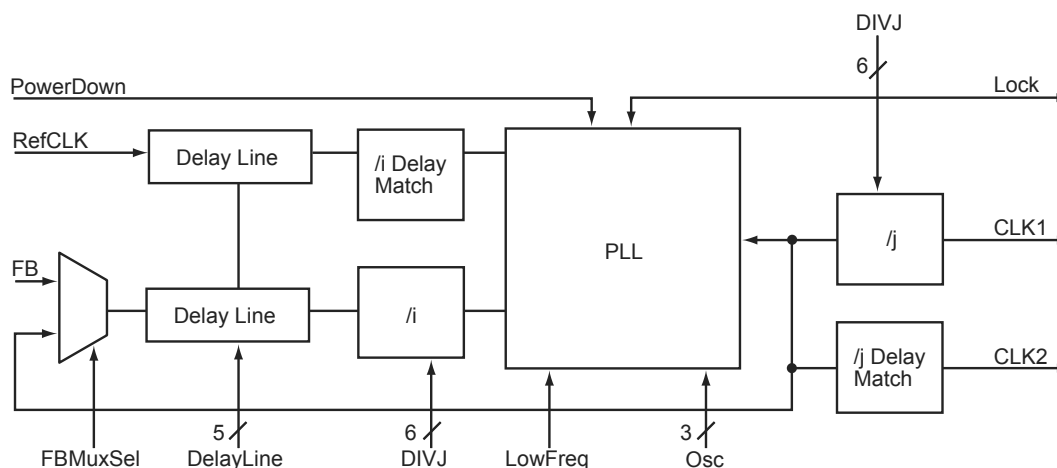


Figure 2-48 • PLL Block Diagram

Note: The VCOMPPLL pin should never be grounded (Figure 2-2 on page 2-9)!

The I/O pads associated with the PLL can also be configured for regular I/O functions except when it is used as a clock buffer. The I/O pads can be configured in all the modes available to the regular I/O pads in the same I/O bank. In particular, the [H]CLKxP pad can be configured as a differential pair,

6. AX2000-CQ256 does not support operation of the phase-locked loops. This is in order to support full pin compatibility with RTAX2000S/SL-CQ256.

Glitch Elimination

An analog filter is added to each FIFO controller to guarantee glitch-free FIFO-flag logic.

Overflow and Underflow Control

The counter MSB keeps track of the difference between the read address (RA) and the write address (WA). The EMPTY flag is set when the read and write addresses are equal. To prevent underflow, the write address is double-sampled by the read clock prior to comparison with the read address (part A in Figure 2-64). To prevent overflow, the read address is double-sampled by the write clock prior to comparison to the write address (part B in Figure 2-64).

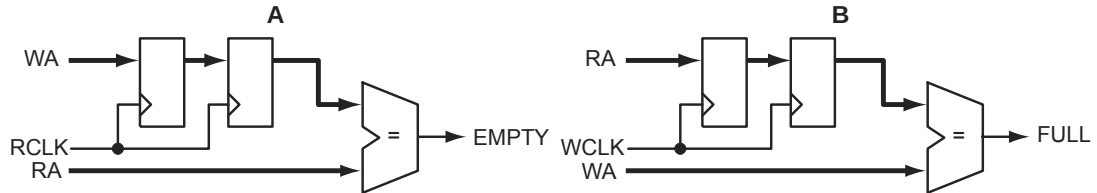


Figure 2-64 • Overflow and Underflow Control

FIFO Configurations

Unlike the RAM, the FIFO's write width and read width cannot be specified independently. For the FIFO, the write and read widths must be the same. The WIDTH pins are used to specify one of six allowable word widths, as shown in Table 2-96.

Table 2-96 • FIFO Width Configurations

WIDTH(2:0)	W x D
000	1 x 4k
001	2 x 2k
010	4 x 1k
011	9 x 512
100	18 x 256
101	36 x 128
11x	reserved

The DEPTH pins allow RAM cells to be cascaded to create larger FIFOs. The four pins allow depths of 2, 4, 8, and 16 to be specified. Table 2-86 on page 2-87 describes the FIFO depth options for various data width and memory blocks.

Interface

Figure 2-65 on page 2-99 shows a logic block diagram of the Accelerator FIFO module.

Cascading FIFO Blocks

FIFO blocks can be cascaded to create deeper FIFO functions. When building larger FIFO blocks, if the word width can be fractured in a multi-bit FIFO, the fractured word configuration is recommended over a cascaded configuration. For example, 256x36 can be configured as two blocks of 256x18. This should be taken into account when building the FIFO blocks manually. However, when using SmartGen, the user only needs to specify the depth and width of the necessary FIFO blocks. SmartGen automatically configures these blocks to optimize performance.

Programming

Device programming is supported through the Silicon Sculptor II, a single-site, robust and compact device programmer for the PC. Up to four Silicon Sculptor IIs can be daisy-chained and controlled from a single PC host. With standalone software for the PC, Silicon Sculptor II is designed to allow concurrent programming of multiple units from the same PC when daisy-chained.

Silicon Sculptor II programs devices independently to achieve the fastest programming times possible. Each fuse is verified by Silicon Sculptor II to ensure correct programming. Furthermore, at the end of programming, there are integrity tests that are run to ensure that programming was completed properly. Not only does it test programmed and nonprogrammed fuses, Silicon Sculptor II also provides a self-test to test its own hardware extensively.

Programming an Axcelerator device using Silicon Sculptor II is similar to programming any other antifuse device. The procedure is as follows:

1. Load the *.AFM file.
2. Select the device to be programmed.
3. Begin programming.

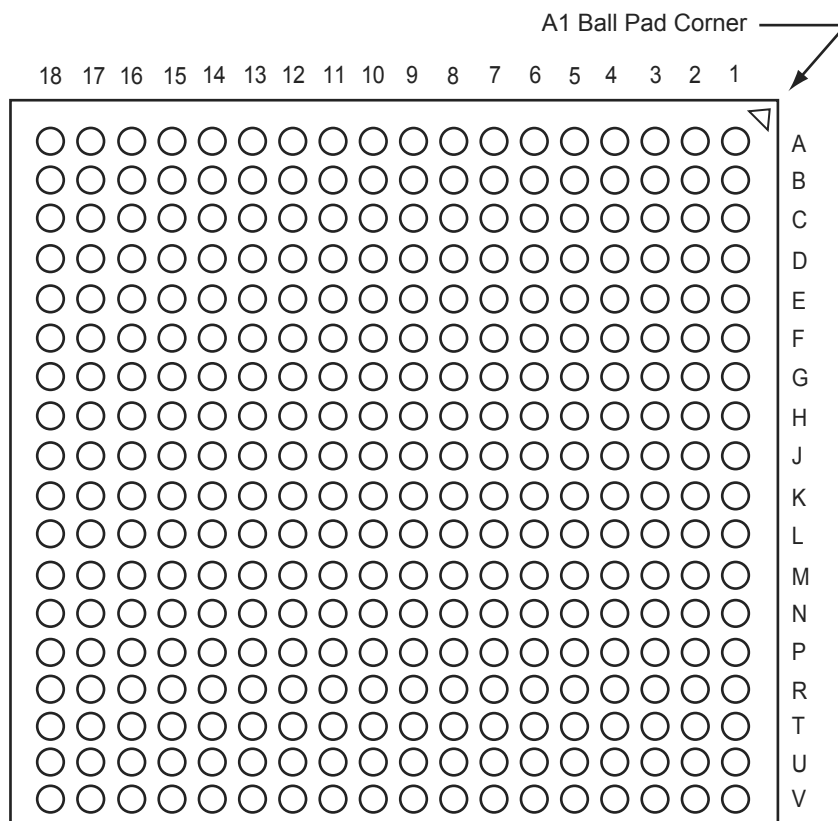
When the design is ready to go to production, Microsemi offers device volume-programming services either through distribution partners or via our In-House Programming Center.

In addition, BP Microsystems offers multi-site programmers that provide qualified support for Axcelerator devices.

For more details on programming the Axcelerator devices, please refer to the *Silicon Sculptor II User's Guide*.

FG256-Pin FBGA		FG256-Pin FBGA		FG256-Pin FBGA	
AX125 Function	Pin Number	AX125 Function	Pin Number	AX125 Function	Pin Number
Bank 6		IO81NB7F7	C2	GND	M12
IO60NB6F6	L4	IO81PB7F7	B1	GND	M5
IO60PB6F6	M4	IO82NB7F7	D2	GND	P13
IO61NB6F6	L3	IO82PB7F7	D3	GND	P3
IO61PB6F6	M3	IO83NB7F7	E3	GND	R15
IO63NB6F6	P2	IO83PB7F7	F3	GND	R2
IO63PB6F6	N2	Dedicated I/O		GND	T1
IO64NB6F6	J4	VCCDA	E4	GND	T16
IO64PB6F6	K4	GND	A1	GND/LP	D4
IO65NB6F6	N1	GND	A16	NC	A11
IO65PB6F6	P1	GND	B15	NC	R11
IO67NB6F6	L2	GND	B2	NC	R5
IO67PB6F6	M2	GND	D15	PRA	D8
IO69NB6F6	L1	GND	E12	PRB	C8
IO69PB6F6	M1	GND	E5	PRC	N9
IO70NB6F6	J3	GND	F11	PRD	P9
IO70PB6F6	K3	GND	F6	TCK	D5
IO71NB6F6	J2	GND	G10	TDI	C6
IO71PB6F6	K2	GND	G7	TDO	C4
Bank 7		GND	G8	TMS	C3
IO72NB7F7	J1	GND	G9	TRST	C5
IO72PB7F7	K1	GND	H10	VCCA	D14
IO73NB7F7	G2	GND	H7	VCCA	F10
IO73PB7F7	H2	GND	H8	VCCA	F4
IO74NB7F7	G3	GND	H9	VCCA	F7
IO74PB7F7	H3	GND	J10	VCCA	F8
IO75NB7F7	E1	GND	J7	VCCA	F9
IO75PB7F7	F1	GND	J8	VCCA	G11
IO76NB7F7	G1	GND	J9	VCCA	G6
IO77NB7F7	E2	GND	K10	VCCA	H11
IO77PB7F7	F2	GND	K7	VCCA	H6
IO78NB7F7	G4	GND	K8	VCCA	J11
IO78PB7F7	H4	GND	K9	VCCA	J6
IO79NB7F7	C1	GND	L11	VCCA	K11
IO79PB7F7	D1	GND	L6	VCCA	K6

FG324



Note

For Package Manufacturing and Environmental information, visit Resource center at <http://www.microsemi.com/soc/products/rescenter/package/index.html>.

FG484	
AX500 Function	Pin Number
IO163NB7F15	G5
IO163PB7F15	G6
IO164NB7F15	D1
IO164PB7F15	E1
IO165NB7F15	F4
IO165PB7F15	G4
IO166NB7F15	D2
IO166PB7F15	E2
IO167NB7F15	F5
IO167PB7F15	E4
Dedicated I/O	
VCCDA	H7
GND	A1
GND	A11
GND	A12
GND	A2
GND	A21
GND	A22
GND	AA1
GND	AA2
GND	AA21
GND	AA22
GND	AB1
GND	AB11
GND	AB12
GND	AB2
GND	AB21
GND	AB22
GND	B1
GND	B2
GND	B21
GND	B22
GND	C20
GND	C3
GND	D19

FG484	
AX500 Function	Pin Number
GND	D4
GND	E18
GND	E5
GND	G18
GND	H15
GND	H8
GND	J14
GND	J9
GND	K10
GND	K11
GND	K12
GND	K13
GND	L1
GND	L10
GND	L11
GND	L12
GND	L13
GND	L22
GND	M1
GND	M10
GND	M11
GND	M12
GND	M13
GND	M22
GND	N10
GND	N11
GND	N12
GND	N13
GND	P14
GND	P9
GND	R15
GND	R8
GND	U16
GND	U6
GND	V18

FG484	
AX500 Function	Pin Number
GND	V5
GND	W19
GND	W4
GND	Y20
GND	Y3
GND/LP	G7
NC	AB8
NC	AB16
NC	C10
NC	C11
NC	C14
PRA	G11
PRB	F11
PRC	T12
PRD	U12
TCK	G8
TDI	F9
TDO	F7
TMS	F6
TRST	F8
VCCA	G17
VCCA	J10
VCCA	J11
VCCA	J12
VCCA	J13
VCCA	J7
VCCA	K14
VCCA	K9
VCCA	L14
VCCA	L9
VCCA	M14
VCCA	M9
VCCA	N14
VCCA	N9
VCCA	P10

FG484	
AX1000 Function	Pin Number
Bank 0	
IO01NB0F0	E3
IO01PB0F0	D3
IO02NB0F0	E7
IO02PB0F0	E6
IO05NB0F0	D2
IO05PB0F0	E2
IO06NB0F0	C5
IO06PB0F0	C4
IO12NB0F1	D7
IO12PB0F1	D6
IO13NB0F1	B5
IO13PB0F1	B4
IO14NB0F1	E9
IO14PB0F1	E8
IO15NB0F1	C7
IO15PB0F1	C6
IO16NB0F1	A5
IO16PB0F1	A4
IO17NB0F1	B7
IO17PB0F1	B6
IO18NB0F1	A7
IO18PB0F1	A6
IO19NB0F1	C9
IO19PB0F1	C8
IO20NB0F1	D9
IO20PB0F1	D8
IO21NB0F1	B9
IO21PB0F1	B8
IO22NB0F2	A9
IO22PB0F2	A8
IO23NB0F2	B10
IO23PB0F2	A10
IO26NB0F2	A14
IO26PB0F2	A13

FG484	
AX1000 Function	Pin Number
IO29NB0F2	B12
IO29PB0F2	B11
IO30NB0F2/HCLKAN	E11
IO30PB0F2/HCLKAP	E10
IO31NB0F2/HCLKBN	D12
IO31PB0F2/HCLKBP	D11
Bank 1	
IO32NB1F3/HCLKCN	F13
IO32PB1F3/HCLKCP	F12
IO33NB1F3/HCLKDN	E14
IO33PB1F3/HCLKDP	E13
IO34NB1F3	C13
IO34PB1F3	C12
IO37NB1F3	B14
IO37PB1F3	B13
IO38NB1F3	A16
IO38PB1F3	A15
IO40NB1F3	C15
IO42NB1F4	A18
IO42PB1F4	A17
IO43NB1F4	B16
IO43PB1F4	B15
IO44NB1F4	B18
IO44PB1F4	B17
IO45NB1F4	B19
IO45PB1F4	A19
IO46NB1F4	C19
IO46PB1F4	C18
IO48NB1F4	F15
IO48PB1F4	F14
IO49NB1F4	D16
IO49PB1F4	D15
IO50NB1F4	C17
IO50PB1F4	C16
IO51NB1F4	E22

FG484	
AX1000 Function	Pin Number
IO51PB1F4	D22
IO52NB1F4	E16
IO52PB1F4	E15
IO57NB1F5	E21
IO57PB1F5	D21
IO60NB1F5	G16
IO60PB1F5	G15
IO61NB1F5	D18
IO61PB1F5	E17
IO63NB1F5	E20
IO63PB1F5	D20
Bank 2	
IO64NB2F6	F18
IO64PB2F6	F17
IO67NB2F6	F19
IO67PB2F6	E19
IO68NB2F6	J16
IO68PB2F6	H16
IO70NB2F6	J17
IO70PB2F6	H17
IO74NB2F7	J18
IO74PB2F7	H18
IO75NB2F7	G20
IO75PB2F7	F20
IO79NB2F7	H19
IO79PB2F7	G19
IO80NB2F7	L16
IO80PB2F7	K16
IO84NB2F7	L17
IO84PB2F7	K17
IO85NB2F8	G21
IO85PB2F8	F21
IO86NB2F8	G22
IO86PB2F8	F22
IO87NB2F8	J20

FG676	
AX1000 Function	Pin Number
GND	A8
GND	AC23
GND	AC4
GND	AD24
GND	AD3
GND	AE2
GND	AE25
GND	AF1
GND	AF13
GND	AF14
GND	AF19
GND	AF26
GND	AF8
GND	B2
GND	B25
GND	B26
GND	C24
GND	C3
GND	G20
GND	G7
GND	H1
GND	H19
GND	H26
GND	H8
GND	J18
GND	J9
GND	K10
GND	K11
GND	K12
GND	K13
GND	K14
GND	K15
GND	K16
GND	K17
GND	L10
GND	L11

FG676	
AX1000 Function	Pin Number
GND	L12
GND	L13
GND	L14
GND	L15
GND	L16
GND	L17
GND	M10
GND	M11
GND	M12
GND	M13
GND	M14
GND	M15
GND	M16
GND	M17
GND	N1
GND	N10
GND	N11
GND	N12
GND	N13
GND	N14
GND	N15
GND	N16
GND	N17
GND	N26
GND	P1
GND	P10
GND	P11
GND	P12
GND	P13
GND	P14
GND	P15
GND	P16
GND	P17
GND	P26
GND	R10
GND	R11

FG676	
AX1000 Function	Pin Number
GND	R12
GND	R13
GND	R14
GND	R15
GND	R16
GND	R17
GND	T10
GND	T11
GND	T12
GND	T13
GND	T14
GND	T15
GND	T16
GND	T17
GND	U10
GND	U11
GND	U12
GND	U13
GND	U14
GND	U15
GND	U16
GND	U17
GND	V18
GND	V9
GND	W1
GND	W19
GND	W26
GND	W8
GND	Y20
GND	Y7
GND/LP	C2
NC	A25
NC	AC13
NC	AC14
NC	AF2
NC	AF25

FG896	
AX1000 Function	Pin Number
IO103NB3F9	V27
IO103PB3F9	U27
IO104NB3F9	W29
IO104PB3F9	V29
IO105NB3F9	Y28
IO105PB3F9	W28
IO106NB3F9	V25
IO106PB3F9	U25
IO107NB3F10	W26
IO107PB3F10	V26
IO108NB3F10	W24
IO108PB3F10	V24
IO109NB3F10	Y27
IO109PB3F10	W27
IO110NB3F10	V23
IO110PB3F10	V22
IO111NB3F10	AA29
IO111PB3F10	Y29
IO112NB3F10	Y25
IO112PB3F10	W25
IO113NB3F10	AB27
IO113PB3F10	AA27
IO114NB3F10	Y23
IO114PB3F10	W23
IO115NB3F10	AA26
IO115PB3F10	Y26
IO116NB3F10	AC28
IO116PB3F10	AB28
IO117NB3F10	AE29
IO117PB3F10	AD29
IO118NB3F11	AE28
IO118PB3F11	AD28
IO119NB3F11	AD27
IO119PB3F11	AC27
IO120NB3F11	AA24

FG896	
AX1000 Function	Pin Number
IO120PB3F11	Y24
IO121NB3F11	AB25
IO121PB3F11	AA25
IO122NB3F11	AC26
IO122PB3F11	AB26
IO123NB3F11	AG28
IO123PB3F11	AF28
IO124NB3F11	AB23
IO124PB3F11	AA23
IO125NB3F11	AF27
IO125PB3F11	AE27
IO126NB3F11	AD25
IO126PB3F11	AC25
IO127NB3F11	AE26
IO127PB3F11	AD26
IO128NB3F11	AC24
IO128PB3F11	AB24
Bank 4	
IO129NB4F12	AD23
IO129PB4F12	AC23
IO130NB4F12	AK26
IO130PB4F12	AK27
IO131NB4F12	AF24
IO131PB4F12	AF25
IO132NB4F12	AG25
IO132PB4F12	AG26
IO133NB4F12	AD22
IO133PB4F12	AC22
IO134NB4F12	AE23
IO134PB4F12	AE24
IO135NB4F12	AH24
IO135PB4F12	AH25
IO136NB4F12	AJ25
IO136PB4F12	AJ26
IO137NB4F12	AD21

FG896	
AX1000 Function	Pin Number
IO137PB4F12	AC21
IO138NB4F12	AK24
IO138PB4F12	AK25
IO139NB4F13	AE21
IO139PB4F13	AE22
IO140NB4F13	AG23
IO140PB4F13	AG24
IO141NB4F13	AF22
IO141PB4F13	AF23
IO142NB4F13	AJ23
IO142PB4F13	AJ24
IO143NB4F13	AD19
IO143PB4F13	AD20
IO144NB4F13	AG21
IO144PB4F13	AG22
IO145NB4F13	AE19
IO145PB4F13	AE20
IO146NB4F13	AF20
IO146PB4F13	AF21
IO147NB4F13	AC19
IO147PB4F13	AC20
IO148NB4F13	AH22
IO148PB4F13	AH23
IO149NB4F13	AC18
IO149PB4F13	AB18
IO150NB4F13	AK21
IO150PB4F13	AJ21
IO151NB4F13	AE18
IO151PB4F13	AD18
IO152NB4F14	AJ20
IO152PB4F14	AK20
IO153NB4F14	AG19
IO153PB4F14	AG20
IO154NB4F14	AH19
IO154PB4F14	AH20

FG896	
AX2000 Function	Pin Number
IO65PB1F6	H20
IO66NB1F6	B23
IO66PB1F6	B21
IO67NB1F6	H21
IO67PB1F6	G21
IO68NB1F6	D22
IO68PB1F6	C22
IO69NB1F6	A25
IO69PB1F6	A24
IO70NB1F6	F22
IO70PB1F6	E22
IO71NB1F6	F21
IO71PB1F6	E21
IO73NB1F6	C24
IO73PB1F6	C23
IO74NB1F6	D24
IO74PB1F6	D23
IO75NB1F6	H23
IO75PB1F6	H22
IO76NB1F7	B25
IO76PB1F7	B24
IO78NB1F7	B26
IO78PB1F7	A26
IO79NB1F7	F23
IO79PB1F7	E23
IO80NB1F7	D25
IO80PB1F7	C25
IO81NB1F7	G23
IO81PB1F7	G22
IO82NB1F7	B27
IO82PB1F7	A27
IO83NB1F7	F24
IO83PB1F7	E24
IO84NB1F7	D26
IO84PB1F7	C26

FG896	
AX2000 Function	Pin Number
IO85NB1F7	F25
IO85PB1F7	E25
Bank 2	
IO86NB2F8	G26
IO86PB2F8	G25
IO87NB2F8	K23
IO87PB2F8	J23
IO88NB2F8	J24
IO88PB2F8	H24
IO89NB2F8	E29
IO89PB2F8	D29
IO90NB2F8	F27
IO90PB2F8	E27
IO91NB2F8	H26
IO91PB2F8	H25
IO92NB2F8	G28
IO92PB2F8	F28
IO93NB2F8	J26
IO93PB2F8	J25
IO94NB2F8	H27
IO94PB2F8	G27
IO95NB2F8	H29
IO95PB2F8	G29
IO96NB2F9	G30
IO96PB2F9	F30
IO97NB2F9	K25
IO97PB2F9	K24
IO98NB2F9	J28
IO98PB2F9	H28
IO99NB2F9	L23
IO99PB2F9	L24
IO100NB2F9	K27
IO100PB2F9	J27
IO101PB2F9	J30
IO102NB2F9	E30

FG896	
AX2000 Function	Pin Number
IO102PB2F9	D30
IO103NB2F9	L26
IO103PB2F9	K26
IO104NB2F9	F29
IO105NB2F9	M25
IO105PB2F9	L25
IO106NB2F9	K30
IO106PB2F9	K29
IO107NB2F10	M23
IO107PB2F10	M24
IO109NB2F10	M27
IO109PB2F10	L27
IO110NB2F10	M28
IO110PB2F10	L28
IO111NB2F10	N22
IO111PB2F10	N23
IO112NB2F10	M29
IO112PB2F10	L29
IO113NB2F10	N26
IO113PB2F10	M26
IO114NB2F10	M30
IO114PB2F10	L30
IO115NB2F10	N28
IO115PB2F10	N27
IO117NB2F10	N25
IO117PB2F10	N24
IO118NB2F11	N29
IO119NB2F11	P22
IO119PB2F11	P23
IO121NB2F11	P25
IO121PB2F11	P24
IO122NB2F11	P28
IO122PB2F11	P27
IO123NB2F11	R26
IO123PB2F11	P26

FG1152		FG1152		FG1152	
AX2000 Function	Pin Number	AX2000 Function	Pin Number	AX2000 Function	Pin Number
IO51PB1F4	J20	IO69NB1F6	C27	IO86NB2F8	J28
IO52NB1F4	B20	IO69PB1F6	C26	IO86PB2F8	J27
IO52PB1F4	A20	IO70NB1F6	H24	IO87NB2F8	M25
IO53NB1F4	F20	IO70PB1F6	G24	IO87PB2F8	L25
IO53PB1F4	E20	IO71NB1F6	H23	IO88NB2F8	L26
IO54NB1F5	B21	IO71PB1F6	G23	IO88PB2F8	K26
IO54PB1F5	A21	IO72NB1F6	B28	IO89NB2F8	G31
IO55NB1F5	K21	IO72PB1F6	A28	IO89PB2F8	F31
IO55PB1F5	J21	IO73NB1F6	E26	IO90NB2F8	H29
IO56NB1F5	D21	IO73PB1F6	E25	IO90PB2F8	G29
IO56PB1F5	C21	IO74NB1F6	F26	IO91NB2F8	K28
IO57NB1F5	G22	IO74PB1F6	F25	IO91PB2F8	K27
IO57PB1F5	G21	IO75NB1F6	K25	IO92NB2F8	J30
IO58NB1F5	E22	IO75PB1F6	K24	IO92PB2F8	H30
IO58PB1F5	E21	IO76NB1F7	D27	IO93NB2F8	L28
IO59NB1F5	D22	IO76PB1F7	D26	IO93PB2F8	L27
IO59PB1F5	C22	IO77NB1F7	B29	IO94NB2F8	K29
IO60NB1F5	B23	IO77PB1F7	A29	IO94PB2F8	J29
IO60PB1F5	A23	IO78NB1F7	D28	IO95NB2F8	K31
IO61NB1F5	H22	IO78PB1F7	C28	IO95PB2F8	J31
IO61PB1F5	H21	IO79NB1F7	H25	IO96NB2F9	J32
IO62NB1F5	C24	IO79PB1F7	G25	IO96PB2F9	H32
IO62PB1F5	C23	IO80NB1F7	F27	IO97NB2F9	M27
IO63NB1F5	F23	IO80PB1F7	E27	IO97PB2F9	M26
IO63PB1F5	F22	IO81NB1F7	J25	IO98NB2F9	L30
IO64NB1F6	B24	IO81PB1F7	J24	IO98PB2F9	K30
IO64PB1F6	A24	IO82NB1F7	D29	IO99NB2F9	N25
IO65NB1F6	J22	IO82PB1F7	C29	IO99PB2F9	N26
IO65PB1F6	K22	IO83NB1F7	H26	IO100NB2F9	M29
IO66NB1F6	B25	IO83PB1F7	G26	IO100PB2F9	L29
IO66PB1F6	A25	IO84NB1F7	F28	IO101NB2F9	L33
IO67NB1F6	K23	IO84PB1F7	E28	IO101PB2F9	L32
IO67PB1F6	J23	IO85NB1F7	H27	IO102NB2F9	K34
IO68NB1F6	F24	IO85PB1F7	G27	IO102PB2F9	K33
IO68PB1F6	E24	Bank 2		IO103NB2F9	N28

CQ208	
AX250 Function	Pin Number
IO110PB7F7	19
IO112NB7F7	16
IO112PB7F7	17
IO117NB7F7	12
IO117PB7F7	13
IO119NB7F7	10
IO119PB7F7	11
IO121PB7F7	7
IO122NB7F7	5
IO122PB7F7	6
IO123NB7F7	3
IO123PB7F7	4
Dedicated I/O	
GND	9
GND	15
GND	21
GND	32
GND	39
GND	46
GND	51
GND	59
GND	65
GND	69
GND	90
GND	94
GND	99
GND	104
GND	113
GND	119
GND	125
GND	136
GND	143
GND	150
GND	155
GND	164
GND	169
GND	173

CQ208	
AX250 Function	Pin Number
GND	194
GND	196
GND	201
GND/LP	208
PRA	184
PRB	183
PRC	80
PRD	79
TCK	205
TDI	204
TDO	203
TMS	206
TRST	207
VCCA	2
VCCA	14
VCCA	38
VCCA	52
VCCA	64
VCCA	93
VCCA	118
VCCA	142
VCCA	156
VCCA	168
VCCA	195
VCCDA	1
VCCDA	26
VCCDA	53
VCCDA	63
VCCDA	78
VCCDA	95
VCCDA	105
VCCDA	130
VCCDA	157
VCCDA	167
VCCDA	182
VCCDA	202
VCCIB0	193

CQ208	
AX250 Function	Pin Number
VCCIB0	200
VCCIB1	163
VCCIB1	172
VCCIB2	135
VCCIB2	149
VCCIB3	112
VCCIB3	124
VCCIB4	89
VCCIB4	98
VCCIB5	58
VCCIB5	68
VCCIB6	31
VCCIB6	45
VCCIB7	8
VCCIB7	20
VCCPLA	189
VCCPLB	187
VCCPLC	178
VCCPLD	176
VCCPLE	85
VCCPLF	83
VCCPLG	74
VCCPLH	72
VCOMPLA	190
VCOMPLB	188
VCOMPLC	179
VCOMPLD	177
VCOMPLE	86
VCOMPLF	84
VCOMPLG	75
VCOMPLH	73
VPUMP	158

CG624	
AX2000 Function	Pin Number
GND	M11
GND	M12
GND	M13
GND	M14
GND	M15
GND	N11
GND	N12
GND	N13
GND	N14
GND	N15
GND	P11
GND	P12
GND	P13
GND	P14
GND	P15
GND	R11
GND	R12
GND	R13
GND	R14
GND	R15
GND	T21
GND	T23
GND	T3
GND	T5
GND	V1
GND	V25
GND	V5
PRA	F13
PRB	A13
PRC	AB12
PRD	AE13
TCK	F5

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
TDI	C5
TDO	F6
TMS	D6
TRST	E6
VCCA	AB20
VCCA	F22
VCCA	F4
VCCA	J17
VCCA	J9
VCCA	K10
VCCA	K11
VCCA	K15
VCCA	K16
VCCA	L10
VCCA	L16
VCCA	R10
VCCA	R16
VCCA	T10
VCCA	T11
VCCA	T15
VCCA	T16
VCCA	U17
VCCA	U9
VCCA	Y4
VCCDA	A12
VCCDA	A14
VCCDA	AA13
VCCDA	AA15
VCCDA	AA20
VCCDA	AA7
VCCDA	AB13
VCCDA	AC11

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

CG624	
AX2000 Function	Pin Number
VCCDA	AD11
VCCDA	AD4
VCCDA	AE12
VCCDA	AE17
VCCDA	B15
VCCDA	C15
VCCDA	C6
VCCDA	D13
VCCDA	E13
VCCDA	E19
VCCDA	F21
VCCDA	G10
VCCDA	G5
VCCDA	N21
VCCDA	N5
VCCDA	W21
VCCIB0	A3
VCCIB0	B3
VCCIB0	C4
VCCIB0	D5
VCCIB0	J10
VCCIB0	J11
VCCIB0	K12
VCCIB1	A23
VCCIB1	B23
VCCIB1	C22
VCCIB1	D21
VCCIB1	J15
VCCIB1	J16
VCCIB1	K14
VCCIB2	C24
VCCIB2	C25

Note: *Not routed on the same package layer and to adjacent LGA pads as its differential pair complement. Recommended to be used as a single-ended I/O.

Datasheet Categories

Categories

In order to provide the latest information to designers, some datasheet parameters are published before data has been fully characterized from silicon devices. The data provided for a given device, as highlighted in the "Axcelerator Family Device Status" table on page iii, is designated as either "Product Brief," "Advance," "Preliminary," or "Production." The definitions of these categories are as follows:

Product Brief

The product brief is a summarized version of a datasheet (advance or production) and contains general product information. This document gives an overview of specific device and family information.

Advance

This version contains initial estimated information based on simulation, other products, devices, or speed grades. This information can be used as estimates, but not for production. This label only applies to the DC and Switching Characteristics chapter of the datasheet and will only be used when the data has not been fully characterized.

Preliminary

The datasheet contains information based on simulation and/or initial characterization. The information is believed to be correct, but changes are possible.

Production

This version contains information that is considered to be final.

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